Plastic Medium-Power Complementary Silicon Transistors

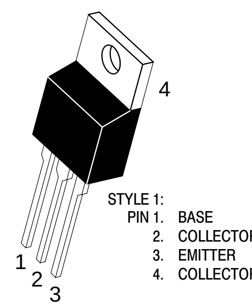
. . . designed for general–purpose amplifier and low–speed switching applications.

- High DC Current Gain —
  h_{FE} = 2500 (Typ) @ I_C
  = 4.0 Adc
- Collector–Emitter Sustaining Voltage — @ 30 mAdc
  $V_{CEO(sus)}$ = 60 Vdc (Min) — TIP100, TIP105
  = 80 Vdc (Min) — TIP101, TIP106
  = 100 Vdc (Min) — TIP102, TIP107
- Low Collector–Emitter Saturation Voltage —
  $V_{CE(sat)}$ = 2.0 Vdc (Max) @ I_C
  = 3.0 Adc
  = 2.5 Vdc (Max) @ I_C = 8.0 Adc
- Monolithic Construction with Built–in Base–Emitter Shunt Resistors
- TO–220AB Compact Package

NPN
TIP100
TIP101*
TIP102*
PNP
TIP105
TIP106*
TIP107*

*ON Semiconductor Preferred Device

DARLINGTON
8 AMPERE
COMPLEMENTARY SILICON
POWER TRANSISTORS
60–80–100 VOLTS
80 WATTS



CASE 221A–09
TO–220AB

*MAXIMUM RATINGS

Rating	Symbol	TIP100, TIP105	TIP101, TIP106	TIP102, TIP107	Unit
Collector–Emitter Voltage	V_{CEO}	60	80	100	Vdc
Collector–Base Voltage	V_{CB}	60	80	100	Vdc
Emitter–Base Voltage	V_{EB}		5.0		Vdc
Collector Current — Continuous Peak	I_C		8.0 15		Adc
Base Current	I_B		1.0		Adc
Total Power Dissipation @ T_C = 25°C Derate above 25°C	P_D		80 0.64		Watts W/°C
Unclamped Inductive Load Energy (1)	E		30		mJ
Total Power Dissipation @ T_A = 25°C Derate above 25°C	P_D		2.0 0.016		Watts W/°C
Operating and Storage Junction Temperature Range	T_J, T_{stg}		–65 to +150		°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.56	°C/W
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	62.5	°C/W

(1) I_C = 1.1 A, L = 50 mH, P.R.F. = 10 Hz, V_{CC} = 20 V, R_{BE} = 100 Ω.

Preferred devices are ON Semiconductor recommended choices for future use and best overall value.

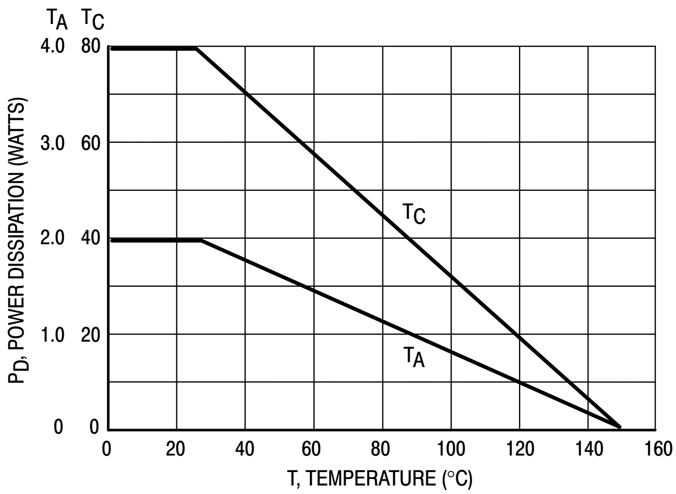


Figure 1. Power Derating

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS					
Collector–Emitter Sustaining Voltage (1)		$V_{CEO(sus)}$			Vdc
(I_C = 30 mAdc, I_B = 0)	TIP100, TIP105		60	—	
	TIP101, TIP106		80	—	
	TIP102, TIP107		100	—	
Collector Cutoff Current		I_{CEO}			μAdc
(V_{CE} = 30 Vdc, I_B = 0)	TIP100, TIP105		—	50	
(V_{CE} = 40 Vdc, I_B = 0)	TIP101, TIP106		—	50	
(V_{CE} = 50 Vdc, I_B = 0)	TIP102, TIP107		—	50	
Collector Cutoff Current		I_{CBO}			μAdc
(V_{CB} = 60 Vdc, I_E = 0)	TIP100, TIP105		—	50	
(V_{CB} = 80 Vdc, I_E = 0)	TIP101, TIP106		—	50	
(V_{CB} = 100 Vdc, I_E = 0)	TIP102, TIP107		—	50	
Emitter Cutoff Current (V_{BE} = 5.0 Vdc, I_C = 0)		I_{EBO}	—	8.0	mAdc
ON CHARACTERISTICS (1)					
DC Current Gain		h_{FE}			—
(I_C = 3.0 Adc, V_{CE} = 4.0 Vdc)			1000	20,000	
(I_C = 8.0 Adc, V_{CE} = 4.0 Vdc)			200	—	
Collector–Emitter Saturation Voltage		$V_{CE(sat)}$			Vdc
(I_C = 3.0 Adc, I_B = 6.0 mAdc)			—	2.0	
(I_C = 8.0 Adc, I_B = 80 mAdc)			—	2.5	
Base–Emitter On Voltage (I_C = 8.0 Adc, V_{CE} = 4.0 Vdc)		$V_{BE(on)}$	—	2.8	Vdc
DYNAMIC CHARACTERISTICS					
Small–Signal Current Gain (I_C = 3.0 Adc, V_{CE} = 4.0 Vdc, f = 1.0 MHz)		h_{fe}	4.0	—	—
Output Capacitance		C_{ob}			pF
(V_{CB} = 10 Vdc, I_E = 0, f = 0.1 MHz)	TIP105, TIP106, TIP107		—	300	
	TIP100, TIP101, TIP102		—	200	

(1) Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.

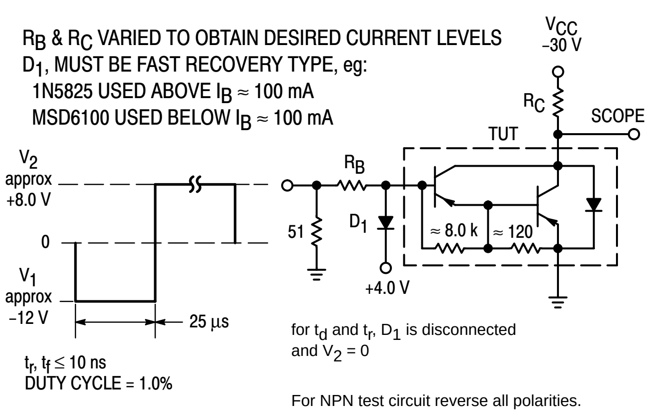


Figure 2. Switching Times Test Circuit

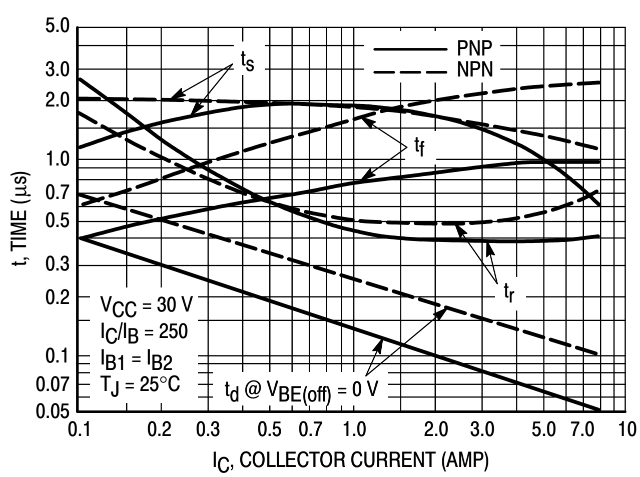


Figure 3. Switching Times

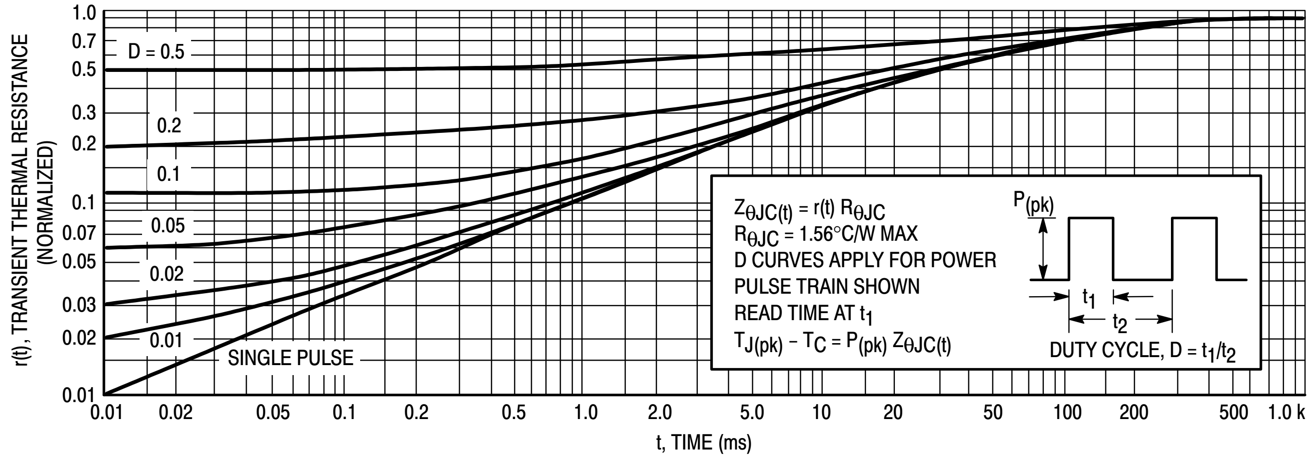


Figure 4. Thermal Response

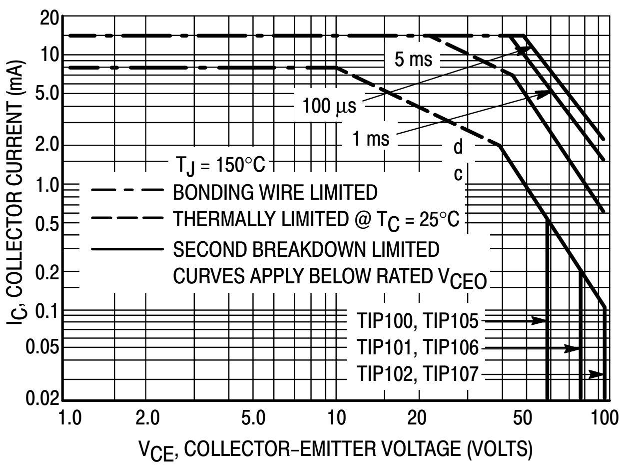


Figure 5. Active−Region Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 5 is based on $T_{J(pk)} = 150°C$; T_C is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} < 150°C$. $T_{J(pk)}$ may be calculated from the data in Figure 4. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown

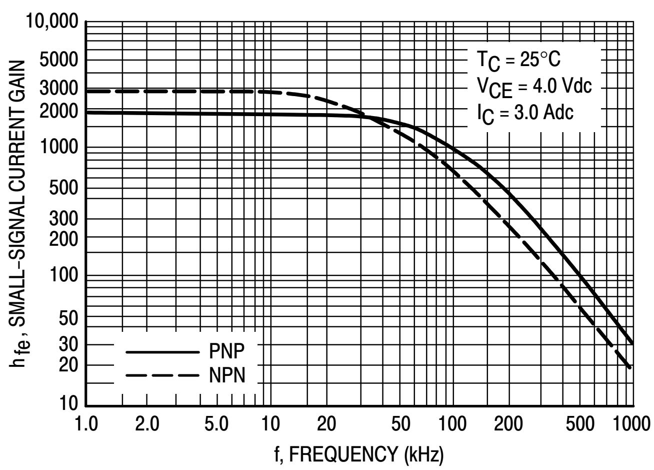


Figure 6. Small−Signal Current Gain

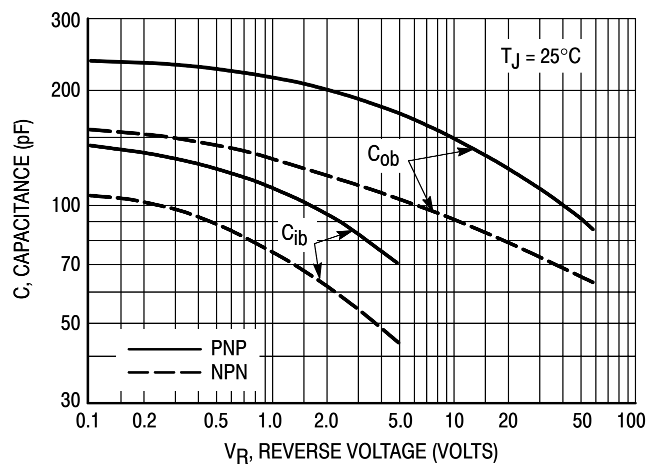
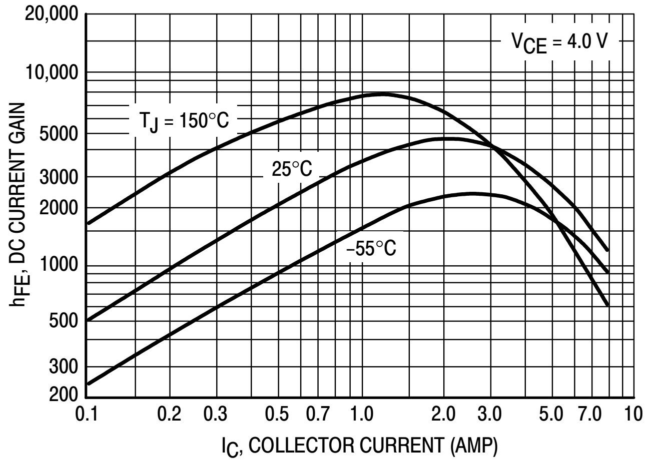


Figure 7. Capacitance

NPN
TIP100, TIP101, TIP102

PNP
TIP105, TIP106, TIP107



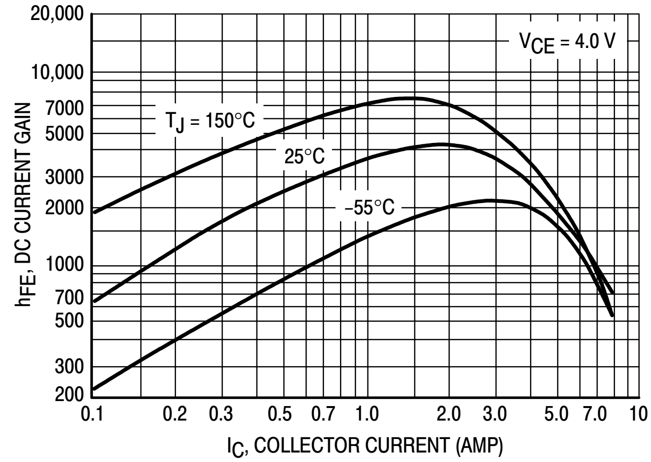
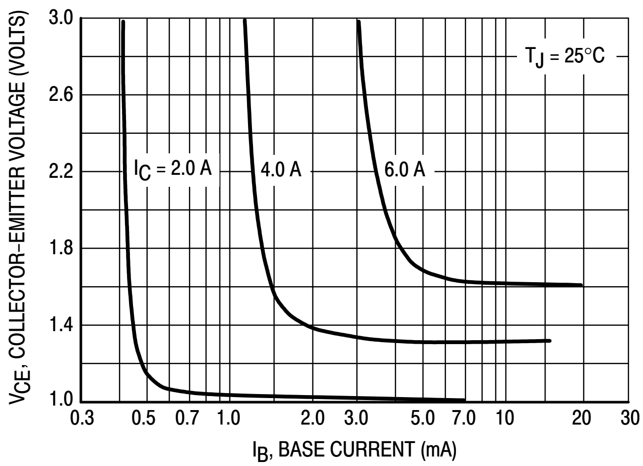


Figure 8. DC Current Gain



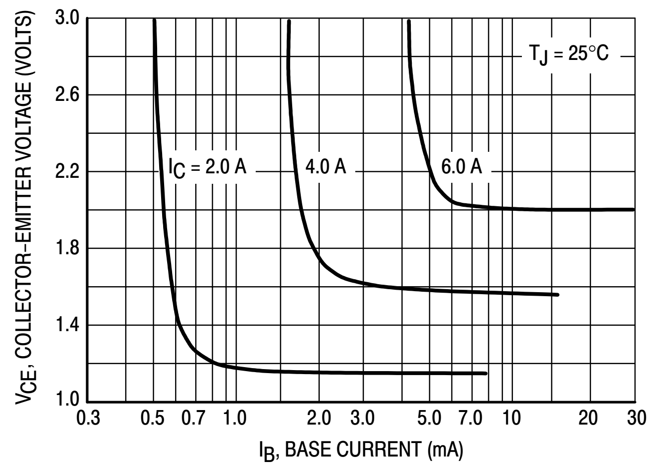
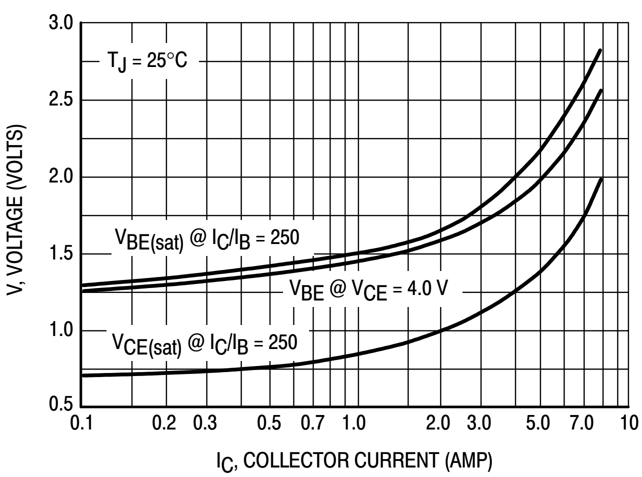


Figure 9. Collector Saturation Region



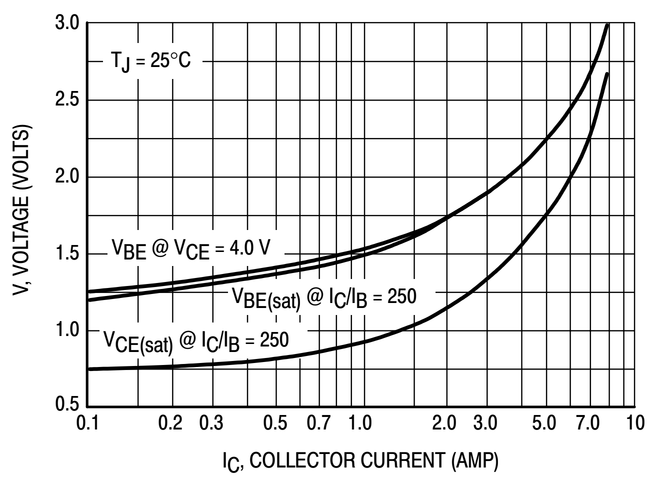
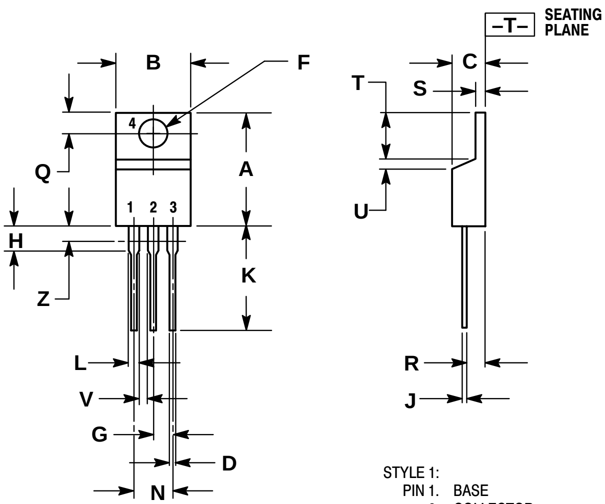


Figure 10. “On” Voltages

PACKAGE DIMENSIONS

TO–220AB
CASE 221A–09
ISSUE AA



STYLE 1:
PIN 1. BASE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.570	0.620	14.48	15.75
B	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
H	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045	---	1.15	---
Z	---	0.080	---	2.04

Notes

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